Schottky Barrier Diode

DB2232000L

Panasonic

DB2232000L

Silicon epitaxial planar type

For rectification

■ Features

- · Low forward voltage VF
- Small reverse leakage current
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol: B5

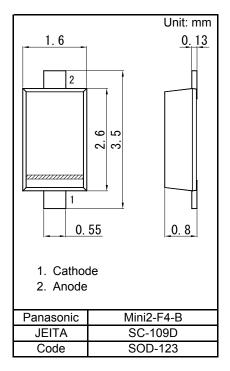
Established: 2010-07-22

Revised

: 2013-04-19

■ Packaging

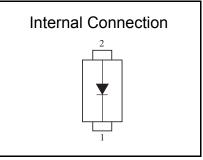
Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)



■ Absolute Maximum Ratings Ta = 25 °C

Parameter	Symbol	Rating	Unit
Reverse voltage	VR	30	V
Repetitive peak reverse voltage	VRRM	30	V
Peak forward current	IF(AV)	1.5	Α
Non-repetitive peak forward surge current ^{*1}	IFSM	30	Α
Junction temperature	Tj	125	°C
Operating ambient temperature	Topr	-40 to +85	°C
Storage temperature	Tstg	-55 to +125	°C

Note: *1 50 Hz sine wave 1 cycle (Non-repetitive peak current)



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■ Electrical Characteristics Ta = 25 °C ± 3 °C

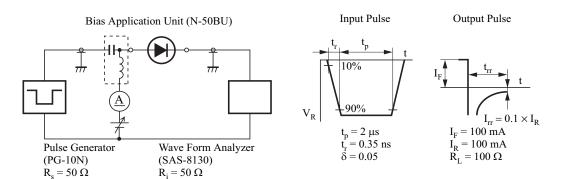
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	VF1	IF = 0.5 A			0.38	V
	VF2	IF = 1.0 A			0.42	V
	VF3	IF = 1.5 A			0.46	V
Reverse current	IR	VR = 30 V			100	μA
Terminal capacitance	Ct	VR = 10 V, f = 1 MHz		48		pF
Reverse recovery time *1	trr	IF = IR = 100 mA		16		ns
	"'	Irr = $0.1 \times IR$, RL = 100Ω				

- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.
 - 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
 - 3. *1 trr test circuit

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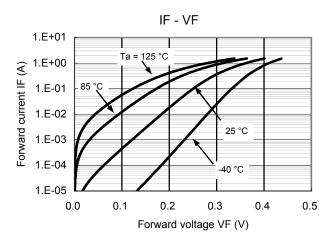


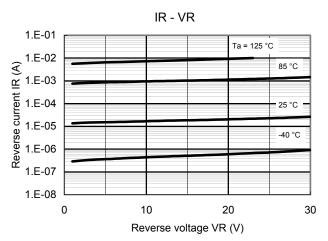
Schottky Barrier Diode

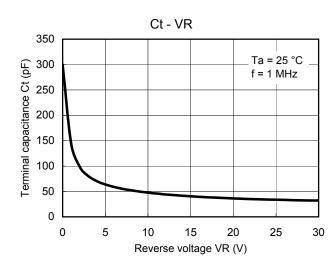
DB2232000L

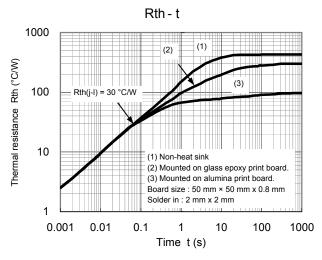
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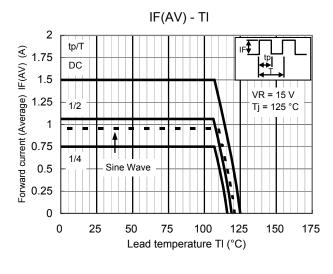
Technical Data (reference)

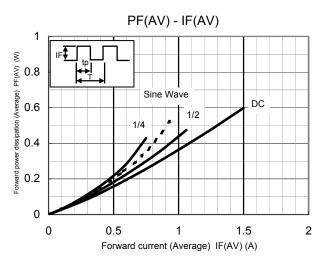












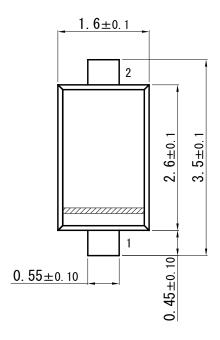
Established: 2010-07-22 Revised: 2013-04-19 **Panasonic**

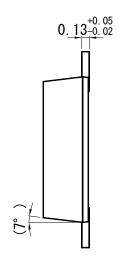
Schottky Barrier Diode

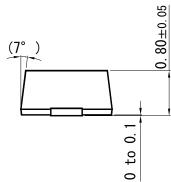
DB2232000L

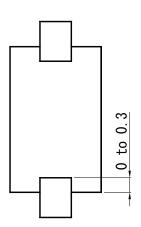
Mini2-F4-B

Unit: mm

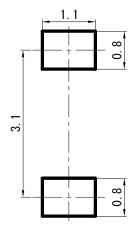








■ Land Pattern (Reference) (Unit: mm)



Established: 2010-07-22 Revised: 2013-04-19

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